

EAST Search History

| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|-------|------|---|--|------------------|---------|---------------------|
| L1 | 0 | ("2003172508").PN. | US-PGPUB; USPAT; USOCR | OR | OFF | 2008/11/05 07:24 |
| L2 | 1 | ("20030172508").PN. | US-PGPUB; USPAT; USOCR | OR | OFF | 2008/11/05 07:25 |
| L3 | 0 | ("2003/0172508").URPN. | USPAT | OR | OFF | 2008/11/05 09:03 |
| L4 | 2 | ("5885353" "6099643").PN. | US-PGPUB; USPAT; FPRS; EPO; JPO | OR | OFF | 2008/11/05 09:03 |
| L5 | 9 | ("6099643").URPN. | USPAT | OR | OFF | 2008/11/05 09:03 |
| L6 | 5 | ("5518542" "5639301" "5792259" "5928390" "5972110").PN. | US-PGPUB; USPAT; USOCR | OR | OFF | 2008/11/05 09:03 |
| L7 | 44 | ("5885353").URPN. | USPAT | OR | OFF | 2008/11/05 09:03 |
| L8 | 18 | ("4640501" "4671250" "4684113" "4693211" "4870923" "4955590" "5382311" "5462603" "5516367" "5564682" "5569350" "5660673" "5665166" "5665167" "5669977" "5695568" "5700725" "5707051").PN. | US-PGPUB; USPAT; USOCR | OR | OFF | 2008/11/05 09:03 |
| L9 | 9 | ("6099643").URPN. | USPAT | OR | OFF | 2008/11/05 09:03 |
| L10 | 5 | ("5518542" "5639301" "5792259" "5928390" "5972110").PN. | US-PGPUB; USPAT; USOCR | OR | OFF | 2008/11/05 09:03 |
| L11 | 44 | ("5885353").URPN. | USPAT | OR | OFF | 2008/11/05 09:03 |

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|-----|-------|---|--|----|-----|---------------------|
| L12 | 18 | ("4640501" "4671250" "4684113" "4693211" "4870923" "4955590" "5382311" "5462603" "5516367" "5564682" "5569350" "5660673" "5665166" "5665167" "5669977" "5695568" "5700725" "5707051"). PN. | US-PGPUB; USPAT; USOCR | OR | OFF | 2008/11/05 09:03 |
| L13 | 58 | (L9 L10 L11 L12) and heat \$3 | US-PGPUB; USPAT; USOCR | OR | OFF | 2008/11/05 09:03 |
| L14 | 9 | ("6099643").URPN. | USPAT | OR | OFF | 2008/11/05 09:05 |
| L15 | 44 | ("5885353").URPN. | USPAT | OR | OFF | 2008/11/05 09:06 |
| L16 | 13213 | (wafer substrate semiconductor) and (drie \$2 dry\$3) and (gas fluid) and heat\$3 and (container chamber enclosure) and (regenerative reheat\$3 recycl\$3) | US-PGPUB; USPAT; FPRS; EPO; JPO | OR | OFF | 2008/11/05 09:33 |
| L17 | 119 | (wafer substrate semiconductor) and (drie \$2 dry\$3) and (gas fluid) and heat\$3 and (container chamber enclosure) and (regenerative reheat\$3 recycl\$3) and "34"/\$.ocls. | US-PGPUB; USPAT; FPRS; EPO; JPO | OR | OFF | 2008/11/05 09:34 |

11/5/2008 9:40:27 AM

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